IN THE CLAIMS

- 1-12. (Canceled).
- 13. (*Currently Amended*) A method for megasonic cleaning of semiconductor wafers comprising the steps of:

generating two or more parallel sets of megasonic waves in a cleaning fluid, the megasonic waves having a <u>common</u> direction of travel and wave fronts that are generally perpendicular to the direction of travel;

immersing semiconductors the wafers in the cleaning fluid; and moving the wafers in the cleaning fluid through two or more of said megasonic waves in a direction that is generally perpendicular to the direction of travel of the megasonic waves and generally perpendicular to the wave fronts of a plane parallel with the megasonic waves.

14. (*Currently Amended*) The method of claim 13 wherein the megasonic waves are generated across parallel regions of the fluid and the step of moving the wafers comprises reciprocating the wafers through <u>at least two of</u> said parallel regions.

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15. (*Previously Presented*) A method for megasonic cleaning of semiconductor wafers disposed within a holder, the holder and wafers disposed in a cleaning fluid within a container, the method comprising the steps of:

generating megasonic waves in the cleaning fluid;

intercepting the generated waves inside the container at a location between one or more sources of the megasonic waves and the holder, and dispersing the waves in a divergent manner; and

exposing the semiconductor wafers to the dispersed megasonic waves within the cleaning fluid.

16-26. (Canceled).

27. (*Currently Amended*) A method for megasonic cleaning of semiconductor wafers comprising the steps of:

generating two or more parallel sets of megasonic waves in a cleaning fluid;

immersing semiconductors the wafers in the cleaning fluid such that faces of the wafers are parallel with the waves; and

moving the wafers in the cleaning fluid through said megasonic waves in a direction that is generally transverse to perpendicular to the megasonic waves and generally perpendicular to the faces of the wafers.

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